

TECHNICAL DATASHEET

SUPERMICRO · STORAGE SERVERS

Supermicro 1U UP Storage Server SSG-110P-NTR10

1U UP front-loading storage server with 10 hot-swap 2.5" NVMe bays and PCIe 4.0

SKU SSG-110P-NTR10

1U

LGA4189

Supermicro



FORM FACTOR

1U

MAX POWER (BASE)

306 W

HEAT OUTPUT

1,044 BTU/h

PRICE

On request

REQUEST A QUOTATION ONLINE

serverinvest.com/product/ssg-110p-ntr10

01 Product overview

The Supermicro SSG-110P-NTR10 is a 1U UP Storage Server built on Intel Xeon Scalable 3rd Gen with up to 2 TB of memory in 8 DIMM slots.

1U UP front-loading storage server with 10 hot-swap 2.5" NVMe bays and PCIe 4.0.

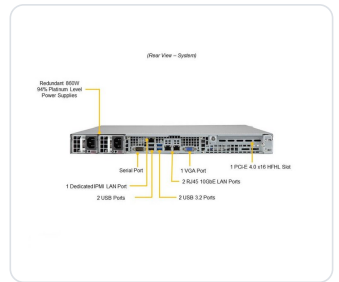
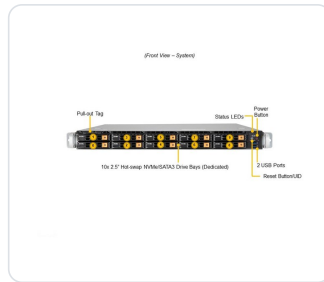
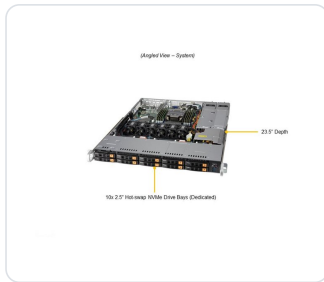
ServerInvest configures every SSG-110P-NTR10 to order, updates BIOS and BMC firmware, installs your operating system on request and runs a 48-hour burn-in test before delivery. Every system includes a 3-year warranty.

HIGHLIGHTS

- Intel Xeon Scalable 3rd Gen
- Up to 2 TB memory · 8 DIMM slots
- Total 10 bays 10 front hot-swap 2.5" PCIe 4.0 NVMe drive bays
- Power: 2x 860W
- Networking: 2 RJ45 10GbE with Intel X550

KEY SPECIFICATIONS

Form factor	1U
Processor	Intel Xeon Scalable 3rd Gen
Socket	LGA4189
Memory	8 DIMM slots, up to 2 TB
Drive bays	10 (10 NVMe)
Power supply	2× 860 W
Typical power draw	450 W
Networking	2 RJ45 10GbE with Intel X550
Dimensions (W×H×D)	437 × 44 mm



02 Power & thermal

Calculated for the base configuration

IDLE	TYPICAL	MAXIMUM	HEAT (MAX)	COOLING	PSU LOAD
73 W	190 W	306 W	1,044 BTU/h	0.3 kW	36%

Typical 190 W · max 306 W · single PSU rating 860 W

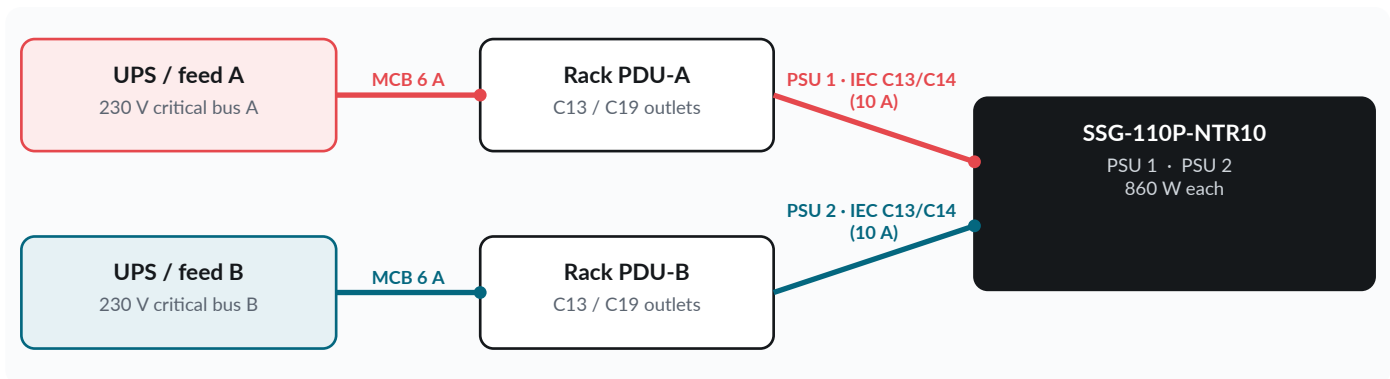
Annual IT energy (24/7)	1,357 kWh
Annual facility energy (PUE 1.5)	2,036 kWh
Annual energy cost	€271 IT · €407 incl. cooling (at 0.20 €/kWh)
CO ₂ emissions / year	0.53 t (grid factor 0.26 kg/kWh)
Power supplies	2× 860 W redundant (N+1)

POWER BY COMPONENT	IDLE	TYPICAL	MAX
Chassis, motherboard, fans, BMC	38 W	59 W	85 W
CPU (base configuration)	25 W	110 W	185 W
2× Memory (base configuration)	6 W	10 W	18 W

DC loads converted to wall power at 94% PSU efficiency; typical load assumed 70% of the time. Engineering estimates — confirm with the manufacturer's power calculator for critical designs.

03 Power connection diagram

Dual-feed (A/B) connection for redundant power supplies



- Connect PSU 1 to PDU-A and PSU 2 to PDU-B (independent feeds) using IEC C13/C14 (10 A) power cords.
- Maximum current per feed: 1.4 A at 230 V — each feed must be able to carry the full load if the other fails.
- Recommended protection per PDU circuit: MCB 6 A, curve C; RCD according to local regulations.
- Heat to remove at full load: 306 W = 1,044 BTU/h (0.3 kW).

04 Full specifications

MOTHERBOARD

Super X12SPO-NTF

PROCESSOR

CPU	Single Socket P+ (LGA-4189) 3rd Gen Intel Xeon Scalable processors
Core Count	Up to 40C/80T; Up to 60MB Cache
Note	Supports up to 270W TDP CPUs (Air Cooled)

SYSTEM MEMORY

Memory	Slot Count: 8 DIMM slots Max Memory (1DPC): Up to 2TB 3200MT/s ECC DDR4 RDIMM/LRDIMM Supports Intel Optane persistent memory 200 series View Memory Options
Memory Voltage	1.2V

ON-BOARD DEVICES

NVMe	NVMe; RAID 0/1/5/10 support(Intel VROC RAID key required) View NVMe Options
Network Connectivity	2 RJ45 10GbE with Intel X550 View AOC Options
BMC	ASPEED AST2600 BMC

INPUT / OUTPUT

LAN	2 RJ45 1 GbE LAN ports 1 RJ45 1 GbE Dedicated BMC LAN port (IPMI shared on LAN port 1)
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USB	2 USB 2.0 ports (header) 2 USB 3.2 Gen1 Type-A ports (rear) 2 USB 2.0 Type-A ports (rear) 2 USB 3.2 Gen1 Type-A ports (front) 1 USB 3.2 Gen1 Type-A port
Video	1 VGA port
Serial	1 COM port (Rear) 1 COM port (Header)
DOM	2 Super DOM (Disk on Module) ports with built-in power
TPM	1 TPM header

SYSTEM BIOS

BIOS Type	AMI 32MB SPI Flash EEPROM
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MANAGEMENT

Software	SuperCloud Composer (SCC) Supermicro Server Manager (SSM) Supermicro Update Manager (SUM) Supermicro SuperDoctor 5 (SD5) Super Diagnostics Offline (SDO) Supermicro Thin-Agent Service (TAS) SuperServer Automation Assistant (SAA) New!
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Power configurations	ACPI/APM Power Management
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SECURITY

Hardware	Trusted Platform Module (TPM) 2.0 Silicon Root of Trust (RoT) – NIST 800-193 Compliant
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Features	Cryptographically Signed Firmware Secure Boot Secure Firmware Updates Automatic Firmware Recovery System Lockdown
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PC HEALTH MONITORING

CPU	7+1 Phase-switching voltage regulator module (VRM) Monitors for CPU Cores, Chipset Voltages, Memory
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Fan	Fans with tachometer monitoring Pulse Width Modulated (PWM) fan connectors Status monitor for speed control
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Temperature	Monitoring for CPU and chassis environment Thermal Control for fan connectors
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CERTIFICATIONS

Operating Systems	ESXi 6.7 U3, ESXi 7.0 U2, ESXi 8.0, Hypervisor 8.2, Oracle Linux 8.3, RHEL 8.3, SLES 12 SP5, SLES 15 SP2, SLES 15 SP3, Windows Server 2019, Windows Server 2022 View all OS Compatibility and Certification Matrix
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CHASSIS

Form Factor	1U Rackmount
Model	CSE-116TS-R860CBP-N10

DIMENSIONS AND WEIGHT

Height	1.7" (43 mm)
Width	17.2" (437 mm)
Depth	23.5" (597 mm)
Package	8" (H) x 24" (W) x 32" (D)
Weight	Gross Weight: 38 lbs (17.24 kg) Net Weight: 25 lbs (11.34 kg)
Available Color	Black

FRONT PANEL

Buttons	Power On/Off UID button
LED	Device Activity LAN 1 Activity LAN 2 Activity Power status System information

EXPANSION SLOTS

PCI-Express (PCIe) Configuration	Default 1 PCIe 4.0 x16 FHHL slot View AOC Options
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DRIVE BAYS / STORAGE

Drive Bays Configuration	Default: Total 10 bays 10 front hot-swap 2.5" PCIe 4.0 NVMe drive bays View NVMe Options
M.2	2 M.2 PCIe 3.0 x4 NVMe/SATA slots (M-key 2280/22110; VROC required for RAID) View M.2 Options

SYSTEM COOLING

Fans	Up to 6 Counter-rotating PWM 40x40x56mm Fan(s)
Air Shroud	1 Air Shroud

POWER SUPPLY

2x 860W
2x 860W Redundant (1 + 1) Platinum Level (94%) power supplies
Dimension (WxHxL)
54.5 x 40.25 x 322 mm

OPERATING ENVIRONMENT

Environmental Spec.	Operating Temperature: 10°C to 35°C (50°F to 95°F) Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)
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05 Built, tested & supported by ServerInvest

Engineered configuration

Every option validated for socket, memory channels, PCIe lanes, power and cooling.

48-hour burn-in

Assembled, firmware-updated and stress-tested before it leaves our workshop.

3-year warranty

Standard on every system, with on-site next-business-day upgrades available.

Rack-ready delivery

Rails, cable management and labelling included — delivered across Europe.



Interested in this solution?

Request a quotation online or talk to a solutions engineer — we reply within one business day.
office@serverinvest.com

Official manufacturer datasheet: serverinvest.com/product/ssg-110p-ntr10/datasheet/manufacturer

